

**Product Family 产品名称: I.**

**Short Product Type 产品名称: IOL, IQ04, OQ06, IQ20, IQ25, IQ40**

Component Name 部件名称	Hazardous Substances 有害物质					
	Lead 铅 (Pb)	Mercury 汞 (Hg)	Cadmium 镉 (Cd)	Hexavalent Chromium 六价铬 (Cr (VI))	Polybro- minated biphenyls 多溴联苯 (PBB)	Polybro- minated diphenyl ethers 多溴二苯醚 (PBDE)
Steel parts 钢部件	X*	O	O	O	O	O
Aluminium parts 铝部件	X*	O	O	O	O	O
High melting temperature type solder 高温熔化焊锡	X*	O	O	O	O	O
Electrical and electronic components containing lead in a glass or ceramic 含有铅的玻璃或陶瓷电子电气 部 件	X*	O	O	O	O	O
Capacitors >125V AC or >250V DC with lead in dielectric ceramic 含铅介电陶瓷电容器(>125V 交流 电或>250V直流电)	X*	O	O	O	O	O
Capacitors with lead in PZT based dielectric ceramic materials 含铅压电(基于介电陶瓷)电容 器	X*	O	O	O	O	O
Flip chip 覆晶技术	X*	O	O	O	O	O
Solder for bonding to ultrasonic transducers 用于超声传感器的焊剂	X*	O	O	O	O	O

This table was developed according to the provisions of SJ/T 11364

本表格依据 SJ/T11364 的□定□制

O: The content of such hazardous substance in all homogeneous materials of such component is **below** the limit required by GB/T 26572.

表示该有害物质在该部件所有均质材料中的含量均在 GB/T 26572 规定的限量要求以下。

X: The content of such hazardous substance in all homogeneous materials of such component is **beyond** the limit required by GB/T 26572..

表示该有害物质至少在该部件的某一均质材料中的含量超出 GB/T 26572 规定的限量要求。

Enterprises may further explain the technical reasons for ticking "X" in the table above according to their actual situation herein.

企业可在此处，根据实际情况对上表中打“×”的技术原因进行进一步说明。

\*Exemptions according to EU RoHS 2011/65 Annex III and IV might be applied

\*欧盟 RoHS 2011/65 附件 III and IV 的豁免可能适用

This statement is based on information and data provided from third parties and may not have been verified through destructive testing methods or other chemical analysis.

本声明基于第三方提供的信息和数据，可能未经破坏性检测方法或其他化学分析进行验证。

#### Producer 生产者

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